

**Recertification  
IPC-7711 and IPC-7721 Certified IPC Specialist (CIS)  
Module 2: Wire Splicing**

Name: \_\_\_\_\_ Date: \_\_\_\_\_

Company Name: \_\_\_\_\_ Workmanship Pass/Fail (instructor circle one)

**Workmanship Critique<sup>1</sup>**

Method Selected	Task Description	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
	Form Wrap Splice or Hook Splice	8.1.2 or 8.1.3			
	Form Lap Splice	8.1.4			

Note 1: Workmanship is graded on pass/fail per the appropriate inspection criteria.

**Module 3: Coating Removal  
Workmanship Pass/Fail (instructor circle one)**

**Workmanship Critique<sup>1,2</sup>**

Method Selected	Task Description	Comp Ref	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
	Remove Coating from Chip		2.3.3 or 2.3.4			
	Remove coating from DIP 14		2.3.5			

Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.

Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.

**Recertification  
IPC-7711 and IPC-7721 Certified IPC Specialist (CIS)  
Module 4: Through Hole Removal**

Name: \_\_\_\_\_ Date: \_\_\_\_\_

Company Name: \_\_\_\_\_ Workmanship Pass/Fail (instructor circle one)

**Workmanship Critique<sup>1, 2</sup>**

Task Description	Comp Ref	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
Remove Axial Component		3.1.1 or 3.1.2			
Remove DIP Component		3.1.1 or 3.1.4			
Remove Radial Component		3.1.1 or 3.1.2			
Install Axial Component					
Install DIP Component					
Install Radial Component					

**Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.**

**Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.**

**Recertification  
IPC-7711 and IPC-7721 Certified IPC Specialist (CIS)  
Module 5: Chip and Melf**

Name: \_\_\_\_\_ Date: \_\_\_\_\_

Company Name: \_\_\_\_\_ Workmanship Pass/Fail (instructor circle one)

**Workmanship Critique<sup>1, 2</sup>**

Task Description	Comp Ref	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
Remove 1206 Chip [Res/Cap]		3.3.1 or 3.3.2			
Remove 1206 MELF		3.3.1 or 3.3.3			
Remove 0603 Chip Capacitor		3.3.2 or 3.3.3			
Remove 0402 Resistor		3.3.1			
Pad Preparation					
Install 1206 Chip [Res/Cap]		5.3.1 or 5.3.2			
Install 1206 MELF		5.3.1 or 5.3.2			
Install 0603 Chip Capacitor		5.3.1 or 5.3.2			
Install 0402 Resistor		5.3.1 or 5.3.2			

**Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.**

**Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.**

**Recertification  
IPC-7711 and IPC-7721 Certified IPC Specialist (CIS)  
Module 6: QFP**

Name: \_\_\_\_\_ Date: \_\_\_\_\_

Company Name: \_\_\_\_\_ Workmanship Pass/Fail (instructor circle one)

**Workmanship Critique<sup>1, 2</sup>**

Task Description	Comp Ref	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
Remove QFP 44 component		3.7.1.1 or 3.7.7			
Remove QFP 100 component		3.7.1 or 3.7.7			
Pad Prep QFP 44		4.1.2 or 4.1.3			
Pad Prep QFP 100		4.1.2 or 4.1.3			
Install QFP 44 component		5.5.3			
Install QFP 100 component		5.5.1			

Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.

Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.

**Module 6: D-Pak  
Workmanship Pass/Fail (instructor circle one)**

**Workmanship Critique<sup>1, 2</sup>**

Task Description	Comp Ref	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
Remove D-PAK component		3.1.2 (Proposed)			
Remove D-PAK component					
Pad Prep					
Pad Prep					
Install D-PAK component		5.9 (Proposed)			
Install D-PAK component					

Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.

Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.

**Recertification  
IPC-7711 and IPC-7721 Certified IPC Specialist (CIS)  
Module 6: SOT and SOIC**

Name: \_\_\_\_\_ Date: \_\_\_\_\_

Company Name: \_\_\_\_\_ Workmanship Pass/Fail (instructor circle one)

**Workmanship Critique<sup>1, 2</sup>**

Task Description	Comp ID	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
Remove SOT component		3.5.1			
Remove SOT component		3.5.2			
Remove SOIC component		3.6.2			
Remove SOIC component		3.6.6			
Pad Prep SOT		4.1.2 or 4.1.3			
Pad Prep SOT		4.1.2 or 4.1.3			
Install SOT Component		5.5.3			
Install SOT Component		5.5.4			
Install SOIC component		5.5.1			
Install SOIC component		5.5.4			

**Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.**

**Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.**

**Recertification  
IPC-7711 and IPC-7721 Certified IPC Specialist (CIS)  
Module 7: J-LEAD**

Name: \_\_\_\_\_ Date: \_\_\_\_\_

Company Name: \_\_\_\_\_ Workmanship Pass/Fail (instructor circle one)

**Workmanship Critique<sup>1,2</sup>**

Task Description	Comp Ref	IPC-7711 Procedure	Student Initials	Instructor Initials	Instructor Comments
Remove J-LEAD component		3.8.2 or 3.8.1.1 or 3.8.5			
Pad Prep					
Install J-LEAD component		5.6.1 or 5.6.2 or 5.6.3 or 5.6.4			

Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.

Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.

**Module 9: Laminate Repair  
Workmanship Pass/Fail (instructor circle one)**

**Workmanship Critique<sup>1,2</sup>**

Task Description	Procedure	Student Initials	Instructor Initials	Instructor Comment
Repair Burned Laminate by Excavation and Epoxy Fill and Resurface	3.5.1			

Note 1: Evaluation is based on appropriate criteria.

Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.

**Recertification  
IPC-7711 and IPC-7721 Certified IPC Specialist (CIS)  
Module 10: Circuit Repair**

Name: \_\_\_\_\_ Date: \_\_\_\_\_

Company Name: \_\_\_\_\_ Workmanship Pass/Fail (instructor circle one)

**Workmanship Critique<sup>2</sup>**

Task Description	Procedure	Student Initials	Instructor Initials	Instructor Comment
Jumper Wire Installation <sup>1</sup>	6.1			
PTH Repair – No inner layer connection <sup>3</sup>	5.1			
Surface Mount Pad Repair <sup>3</sup>	4.7.1 or 4.7.2			

**Note 1: Evaluation is based on the Acceptability Criteria of IPC-A-610, Class 3.**

**Note 2: Workmanship is graded on pass/fail per the appropriate inspection criteria.**

**Note 3: Skills Evaluation based on the appropriate criteria.**